

PEROV project: perovskite devices for visible light and potential for X-ray detection

High Precision X-ray Measurements
22 June 2023

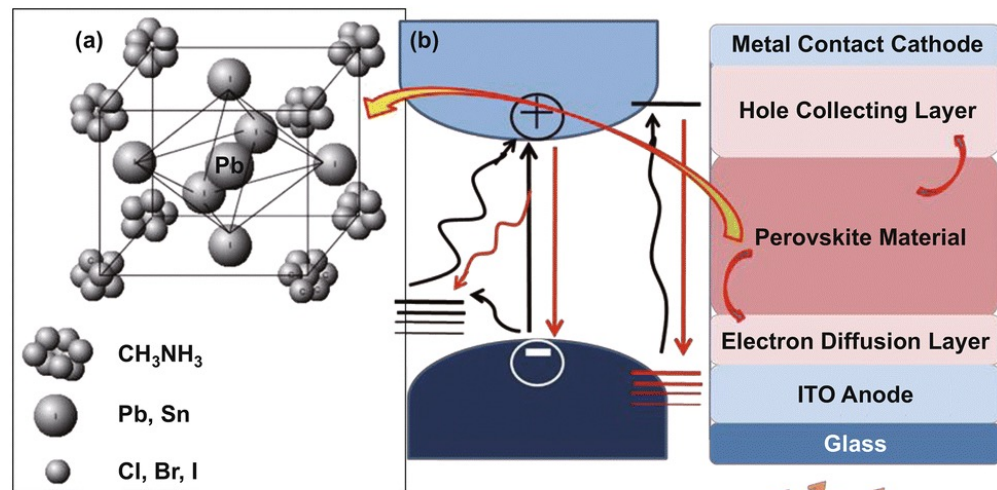
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- Dipartimento Chimica, Uni Milano: L. Lo Presti, S. Rizzato
- CNR – NanoTec, ISR, ISM: L. Di Marco, I. Viola, R. Mastria, S. Sennato
- TIFPA: Lucio Pancheri, Alberto Taffelli

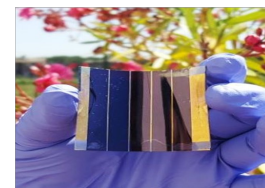
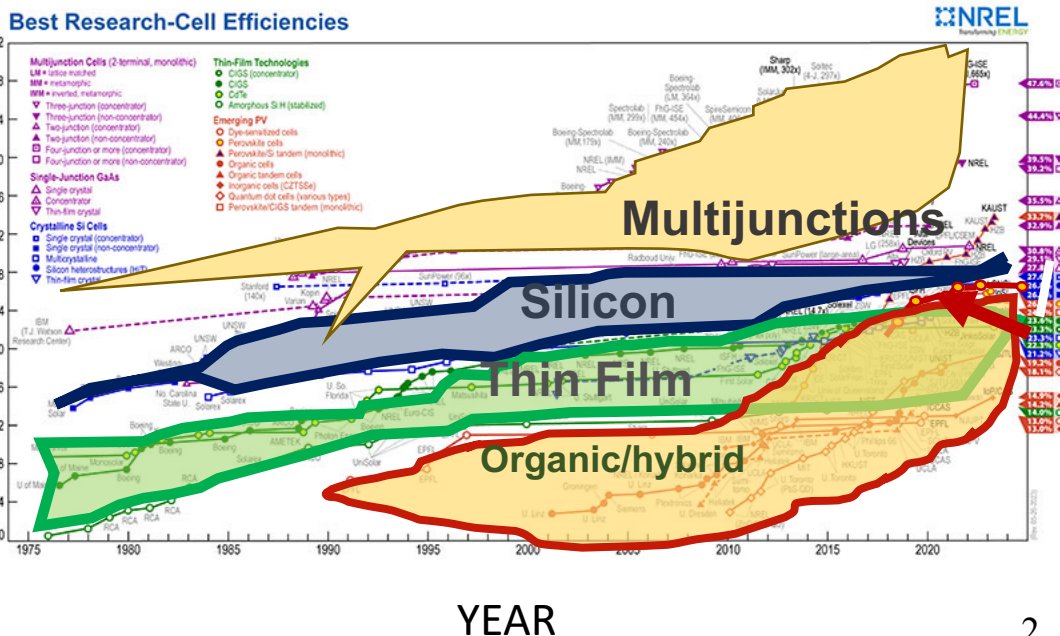
LNF electronic services: G. Papalino, G. Felici

Organo-Metal Halide Perovskite

- **Organo Metal-Halide Perovskites (OMHP)** are a class of hybrid organic-inorganic semiconductor materials with a perovskite unit-cell structure ABX_3 with
 - $A = CH_3NH_3^+$, $B =$ metallic cation (Pb^{2+}), $X =$ halide anions (Cl^- , Br^- , I^-)
- Opto-electronic properties combine advantages from organic and inorganic semiconductors



- Intense R&D in the last decade
 - OMHP are emerging as new generation photovoltaic material
 - **promising candidate**
 - large area and flexible sensitive photodetectors
 - More recently **for radiation detection**



Organo-Metal Halide Perovskite properties

OMHPs combine the advantages of inorganic and organic semiconductors.



Organic semiconductors:

- Disordered system
- Localized electronic states
- Hopping transport \Rightarrow low mobility
- **Low cost, low temperature processing**
- **Can be solution processed**
- **Scalable to large area**

Inorganic semiconductors:

- **Ordered periodic crystal \Rightarrow band structure**
- **Delocalized Bloch states**
- **band transport \Rightarrow high mobility**
- Usually wafer based technology
- Costly, high temperature processes

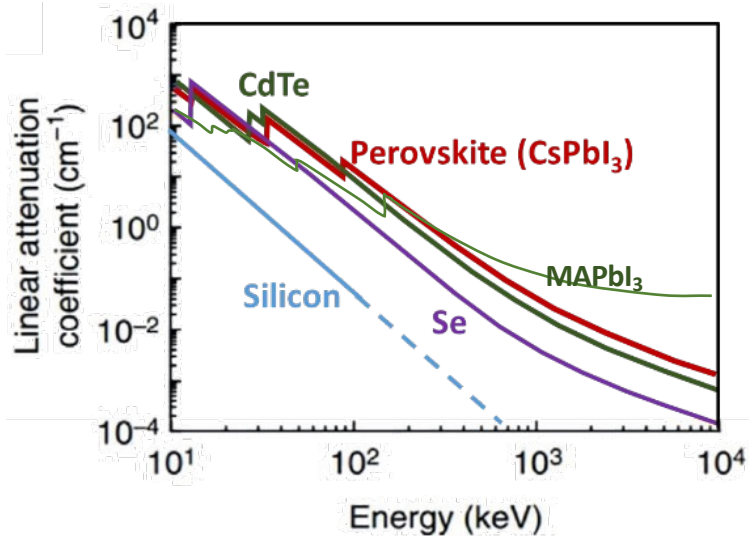
		Silicon	$\text{CH}_3\text{NH}_3\text{Pb}(\text{I},\text{Br})_3$
Density		2.33 g/cm ³	4.15 g/cm ³
Band gap (eV)		1.12 (indirect)	1.5-1.6 / 2.24 (direct)
Mobility (cm ² /Vs)	electrons	1400	< 70/190
	holes	450	< 160/220
Absorption (cm ⁻¹)		< 10 ⁴	> 4x10 ⁴
Threshold energy for impact ionization (eV)		1.2	~2 / 2.5 (estimated)
Mean free path (nm)		\leq 100	~100 (theory)

- band gap tunable changing halide (I,Br,Cl) 
- contain highly mobile defects and have instabilities issues 

Many features of interest for **visible light** detection and **Radiation** detection

Halide Perovskite for ionizing radiations

- The typical composition of HP contains heavy elements (Cs, Pb, Ag, Bi, Sn, I, Br) with atomic numbers in the range of 47-82, larger in comparison to widely used X-ray absorber - CZTS (max atomic number is 52).



Linear attenuation coefficient as a function of photo energy for several materials including halide perovskite
Adapted from (*)

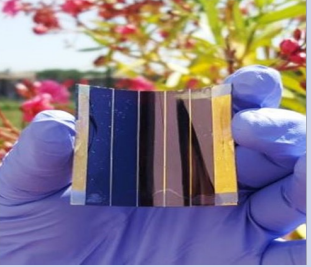
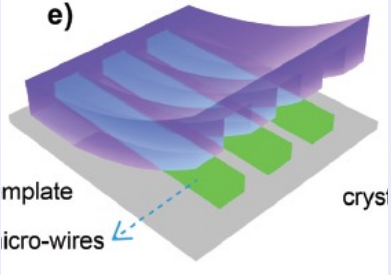
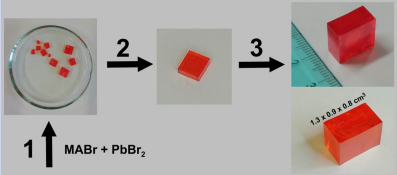
- $(\mu \times \tau)$ product from 10^{-7} to 10^{-2} cm^2/V
- The typical values of the bulk resistivity for HPs exceed the level of 10^7 Ohm.cm (300K), good signal/noise ratio
- Self Healing**

Egger et al. Adv. Mater. 2018, 1800691

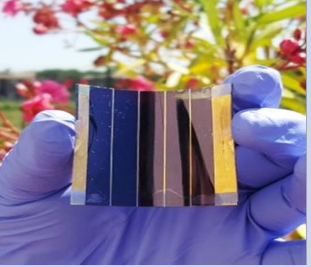
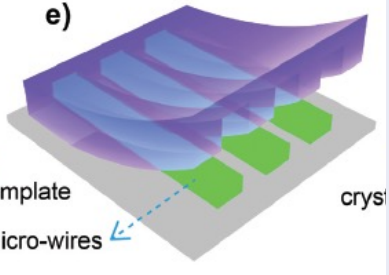
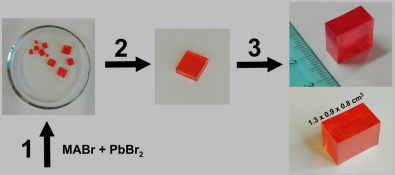
Material	h^+ effective mass [m_e]	e^- effective mass [m_e]	μ_{h^+} [$\text{cm}^2 \text{V}^{-1} \text{s}^{-1}$]	μ_{e^-} [$\text{cm}^2 \text{V}^{-1} \text{s}^{-1}$]
Si ^{b)}	0.54 ^[109]	0.32 ^[110]	500 ^[109]	1500 ^[110]
GaAs ^{b)}	0.53 ^[113]	0.06 ^[113]	400 ^[113]	8000 ^[113]
CdTe ^{b)}	0.72 ^[115,116]	0.11 ^[115,116]	100 ^[117]	1100 ^[117]
CuInS ₂	≈ 1 ^[120]	0.16 ^[120]	≈ 20 ^[120]	≈ 150 ^[120]
MAPbI ₃	0.26 ^[122,123]	0.23 ^[122,123]	≤ 160 ^[124]	≤ 70 ^[124]
MAPbBr ₃ ^{c)}	0.15 ^[127]	0.25 ^[127]	≤ 220 ^[128]	≤ 190 ^[129]

(*)Wei & Huang, J. Nat Commun 2019, 10, 1066; Del Sordo et al. Sensors 2009, 9, ; H.M. Thirimanne et al. Nature Comm 2018, 9, 2926

PEROV: Overview of CH_3PbBr_3 crystal growth

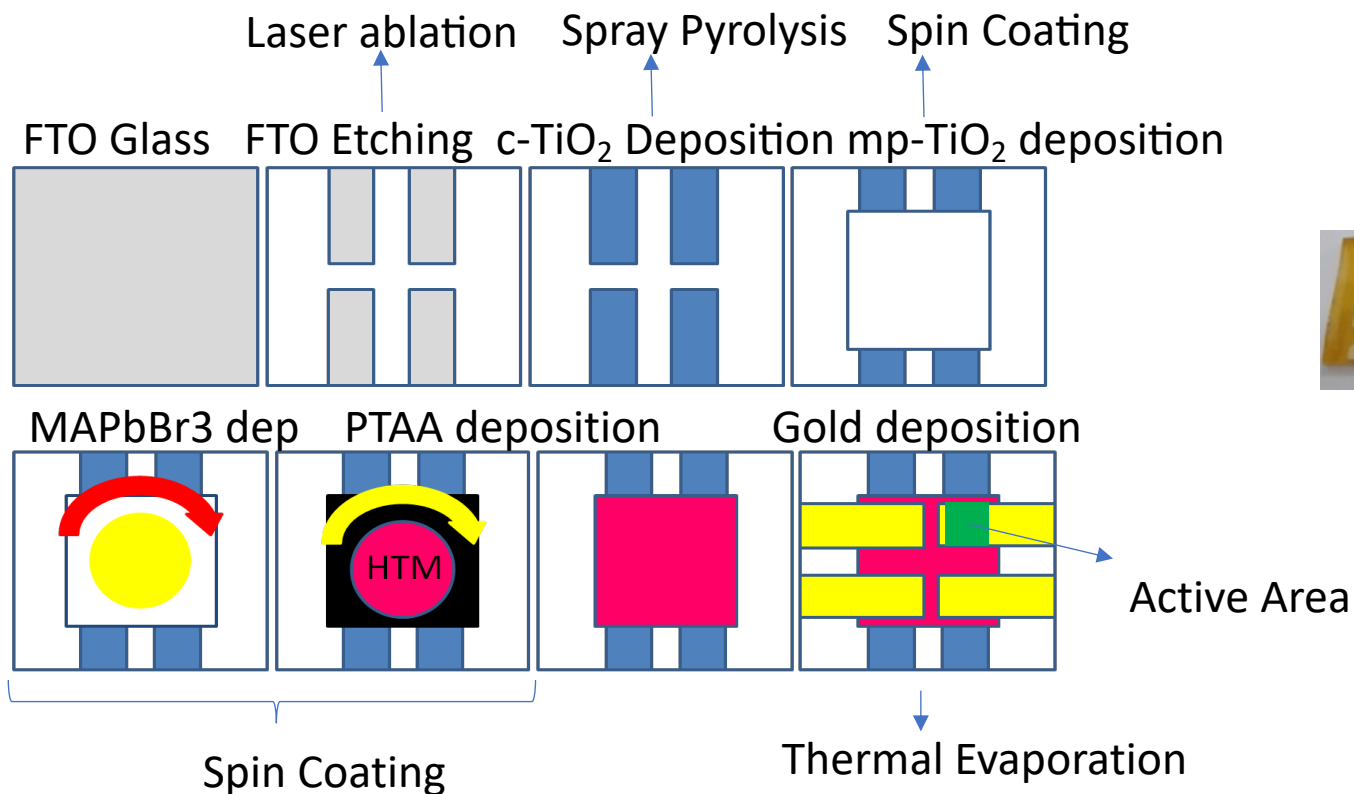
Technology and Thickness	Pro	Contra
<p>Film 300 nm thickness</p> 	<ul style="list-style-type: none"> • large area • small transit time due to low thickness • flexible substrate 	<ul style="list-style-type: none"> • polycrystalline • grain boundaries • large variability between samples
<p>Micro channels 2-6 microns realized</p> 	<ul style="list-style-type: none"> • large flexibility in dimension • moderate area • pixelization • flexible substrate • Deposited directly on substrate 	<ul style="list-style-type: none"> • need high optimization of parameters (pressure, temperature)
<p>Single crystals Up 0.5 cm realized</p> 	<ul style="list-style-type: none"> • ideal for single crystal large dimension, up to $O(1) \text{ cm}^3$ • low defects 	<ul style="list-style-type: none"> • No scalability to large area systems • Need to be cut mechanically for low thickness

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These two technologies can be adapted/used for direct X-rays detection

Film-based devices production

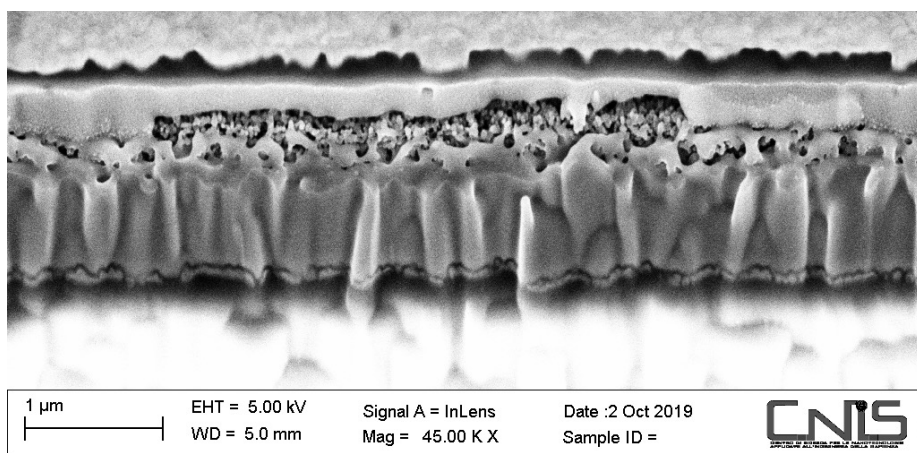


Ready devices with different Optical Band-Gap

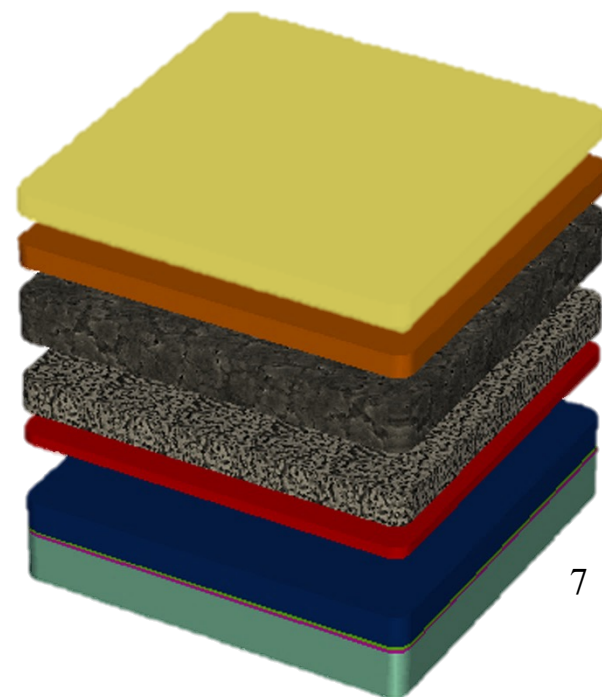


CHOSE lab
Dip Ing. Elettronica RM2

Thin film deposition of MAPbBr₃ perovskite (300nm)



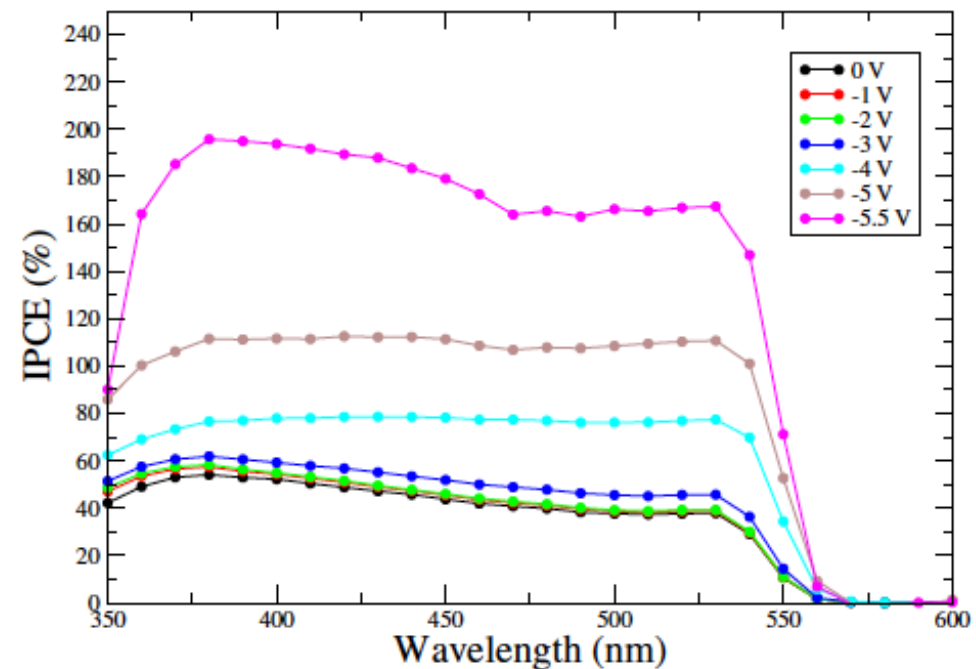
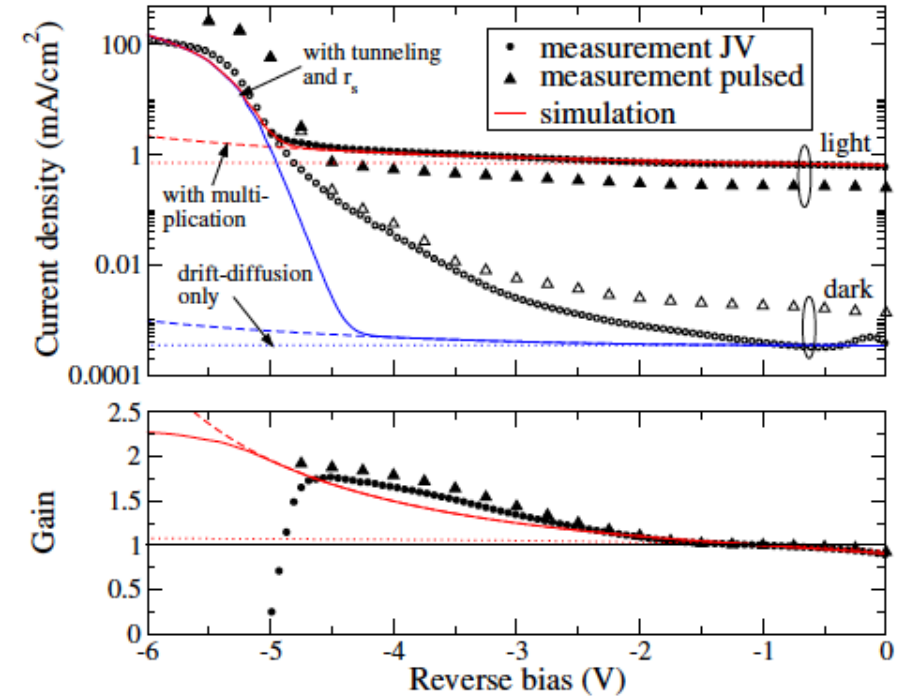
- Materials:
- Au
 - PTAA or MD89
 - MAPbBr₃
 - mp-TiO₂
 - c-TiO₂
 - GLASS/FTO



Film-based devices: gain observation and modelling

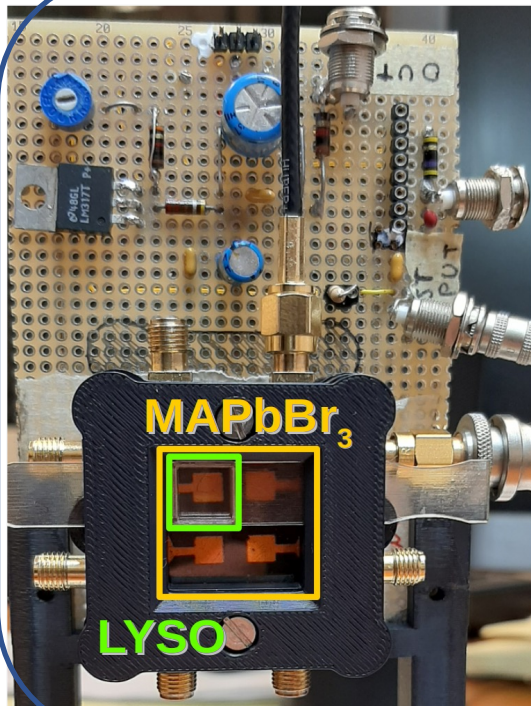
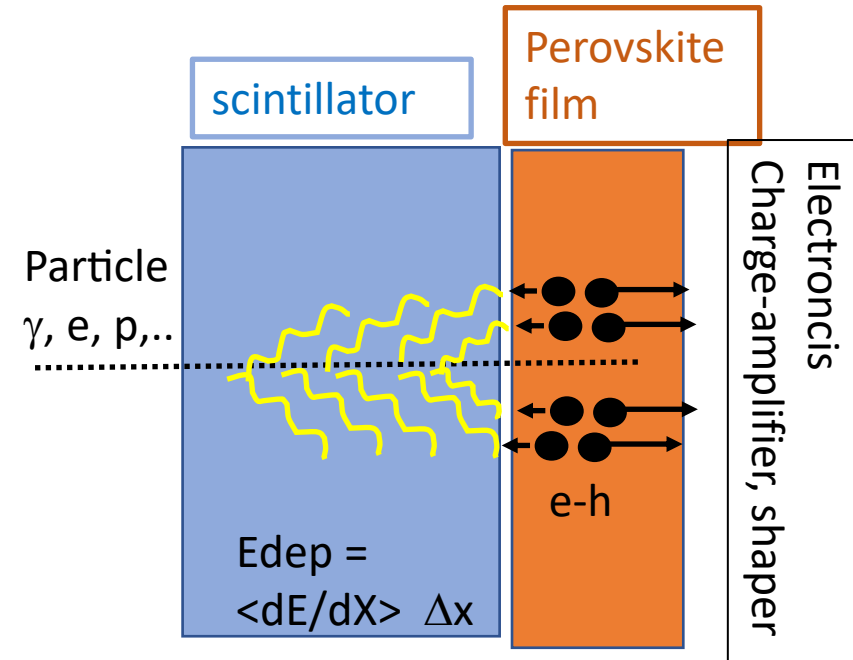
Experimental observation of

- Breakdown-like behavior at around -4–5 V
- Small amount of photocurrent **gain** of ~ 2
 - Incident photon to current efficiency
 $IPCE = J_{ph} hc / (P_{in} e \lambda) \sim 200 \%$
- Developed phenomenological **model** to explain the observed reverse bias behavior and gain though
 - *tunneling-assisted electron extraction at the TiO₂ /MAPbBr₃ interface*
 - *carrier multiplication*
- Both processes mediated by the electric field due to *mobile ions Br-*
- Mobile ionic species in halide play an important role in photodetector and solar cell performance and stability
 - Not fully understood but critical

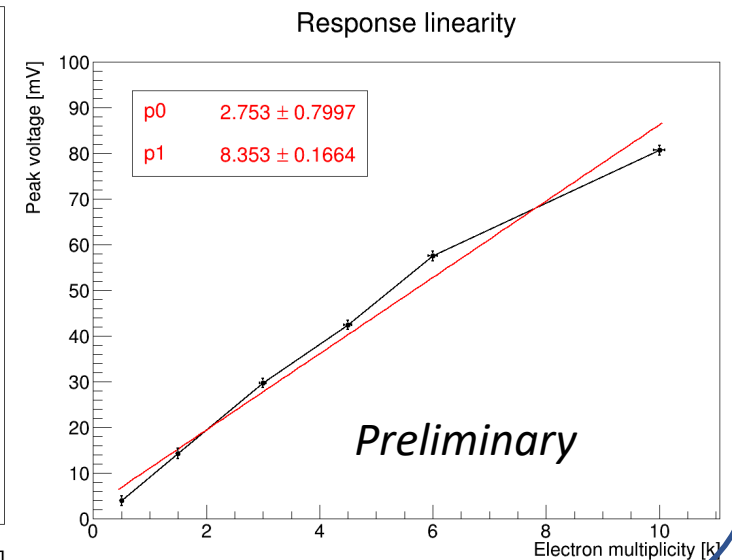
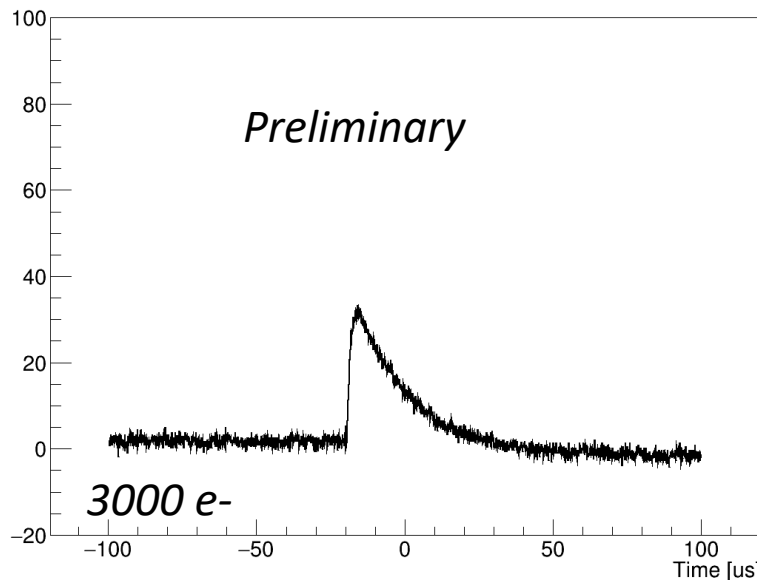


Film-based devices: application for radiation detection

- Film devices can be used in combination with a scintillator (eg LYSO)
- Film not suitable if sensitivity to single photon required (SiPM have gain $\sim 10^6$)
- If large areas need to be covered, light intensity is high and timing performance not stringent, films are good candidate



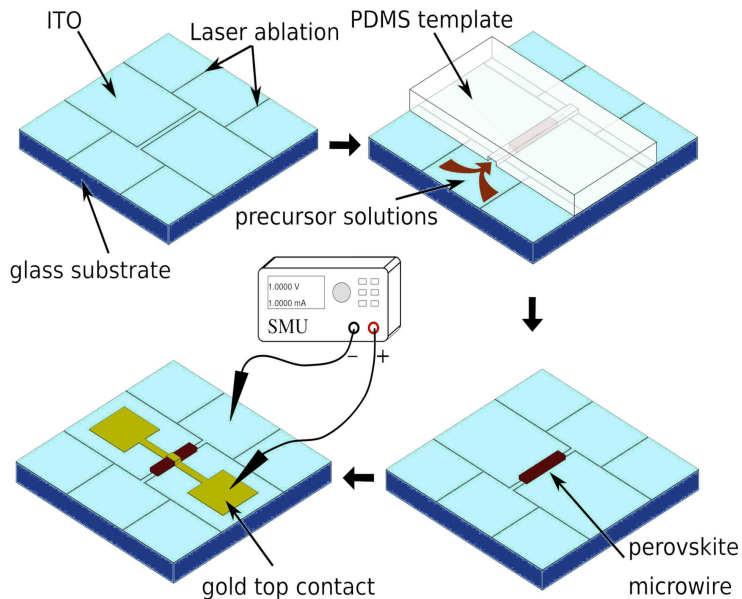
Test Beam performed with electrons of 450 MeV in bunch of 10ns, 3.5 mm width at Beam Test Facility at LNF



Micro-wires on patterned substrate

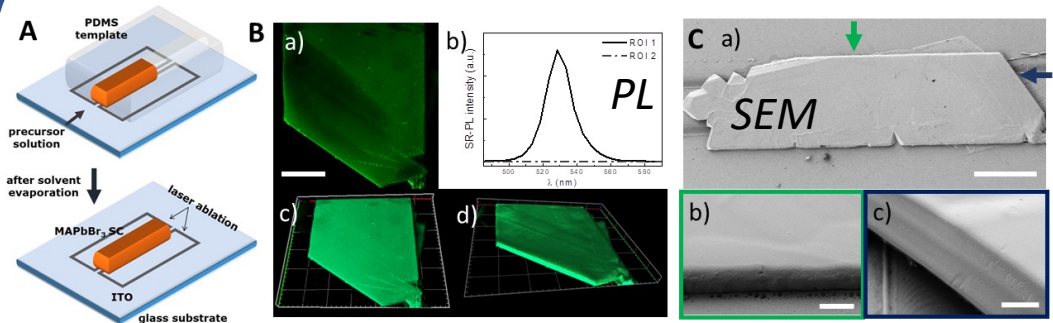
- Microfluidics-assisted technique to realize a controlled growth of OMHP single crystals, in the form of **microwires**, directly on a conductive **patterned substrates** $W \times L \times H = 150 \mu\text{m} \times 500 \mu\text{m} \times 6(2) \mu\text{m}$

Fabrication steps



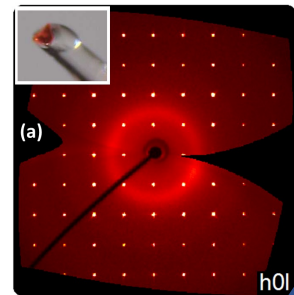
Advanced Material Technology
[10.1002/admt.202300023](https://doi.org/10.1002/admt.202300023)

Material Characterization

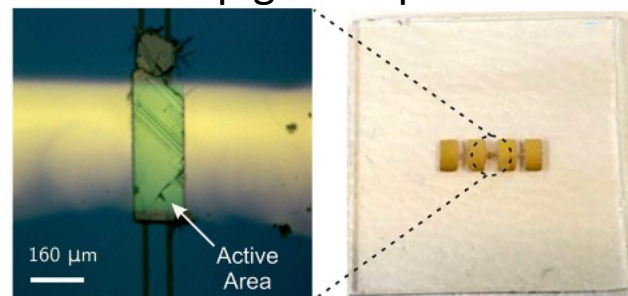


- homogeneous 3D crystalline microstructures, consistent with microchannel used for confinement
- typical photoluminescence of MAPbBr₃
- expected cubic phase with cell length $a=5.927(2) \text{ \AA}$

X-ray diffraction



Top gold deposition

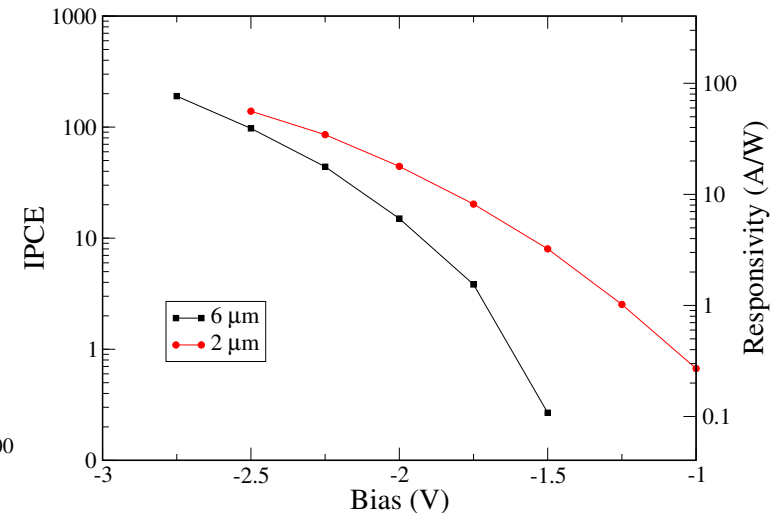
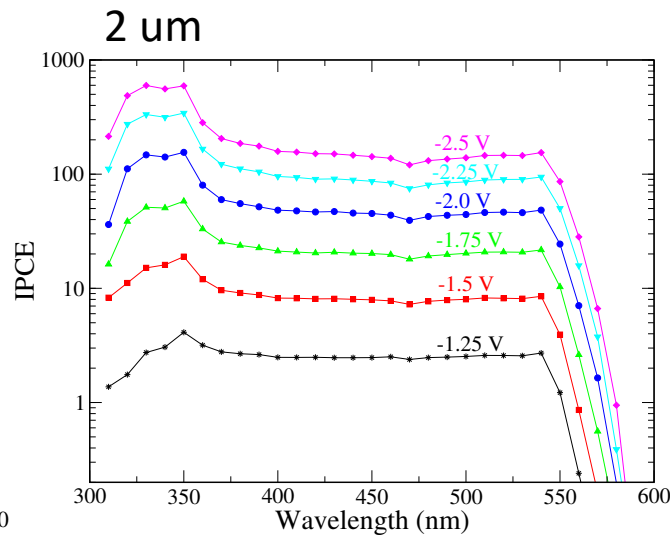
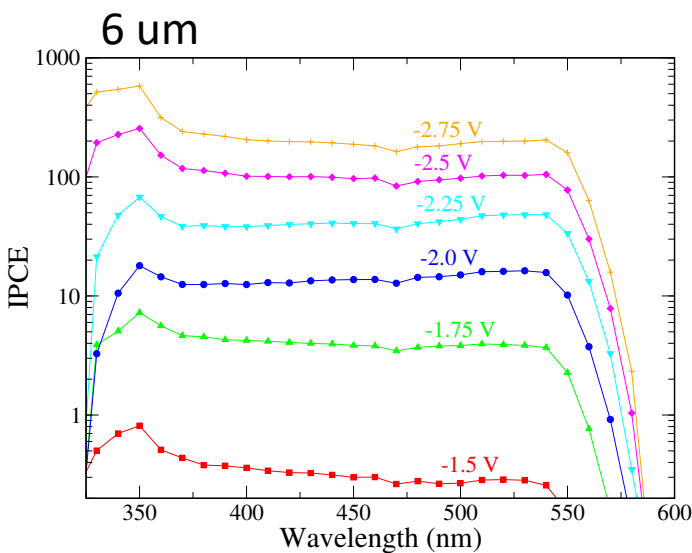
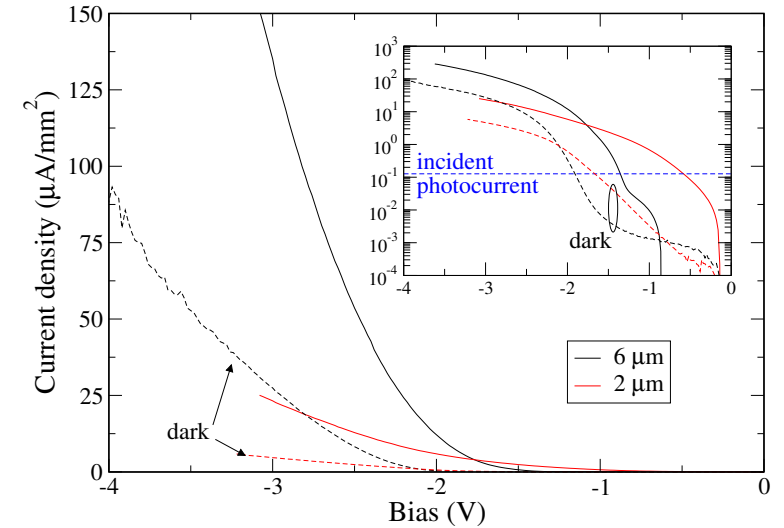


Final vertical device

Deposited patent
 102022000010469

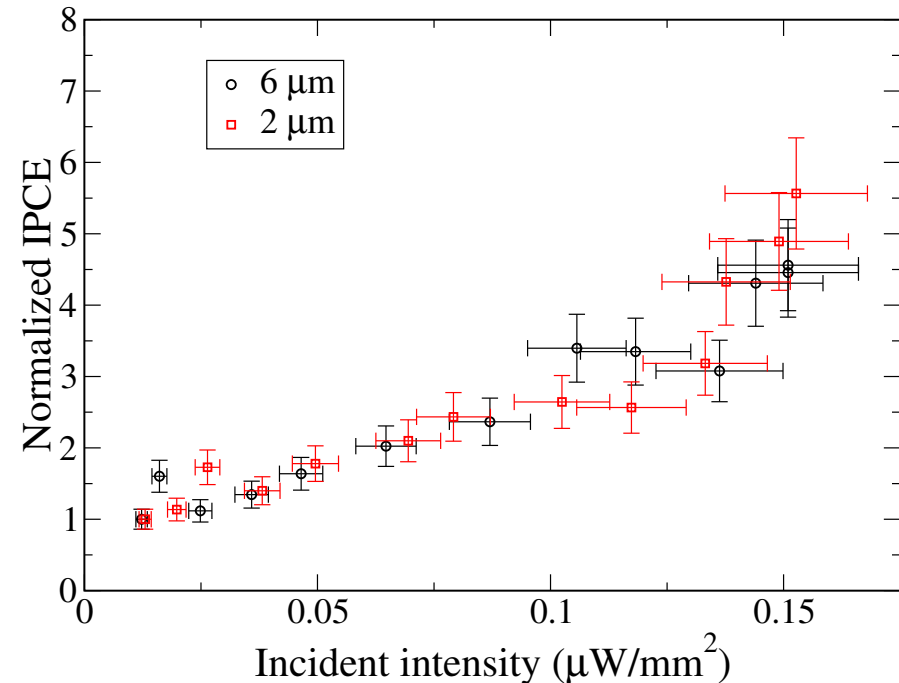
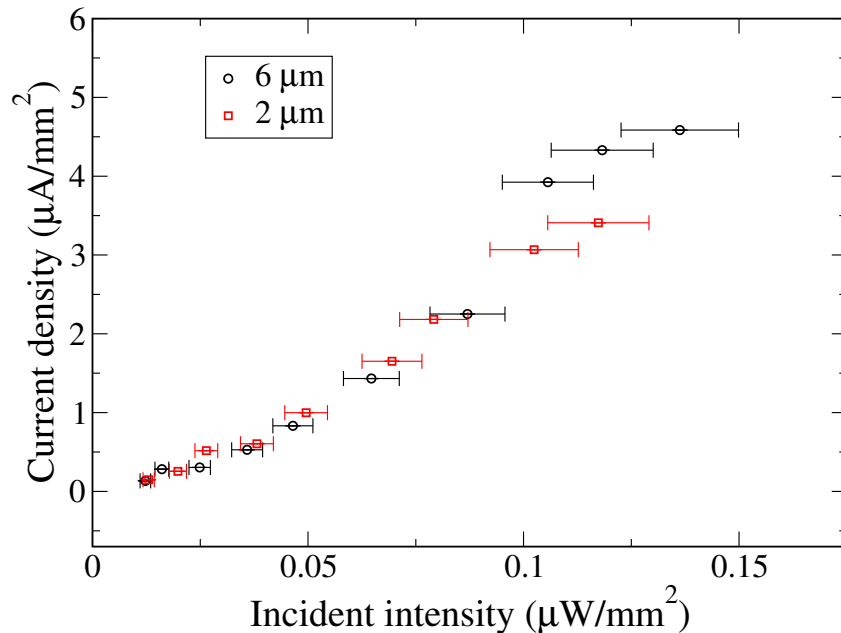
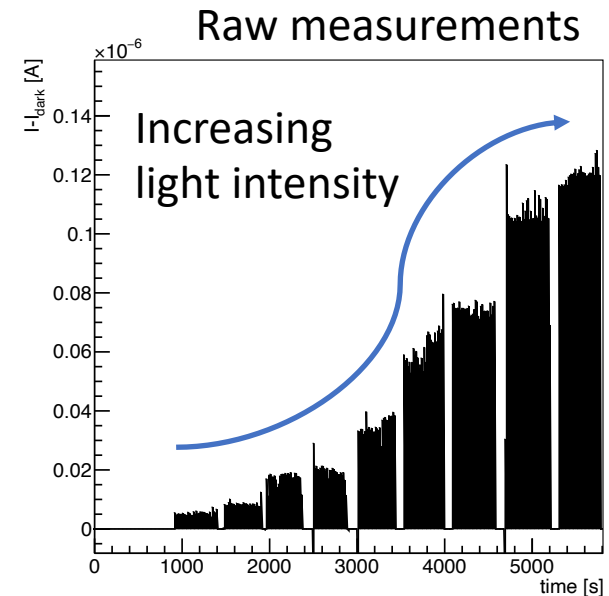
Characterization of micro-channels crystals: JV, IPCE

- 2 and 6 μm thick-devices with active area of 0.034 mm^2 and 0.013 mm^2
- JV curve: trap-filled-limited region at 2 V
 - trap density $\sim 10^{14} - 5 \times 10^{14} \text{ cm}^{-3}$.
- Incident photon to current efficiency
 $\text{IPCE} = J_{\text{ph}} hc / (P_{\text{in}} e \lambda) > 100 \%$
 at bias $> 2\text{-}2.5 \text{ V} \rightarrow$ **Gain** observed
- Similar dark and light JV \rightarrow gain probably due to photoresistive effect, possibly mediated by trap states



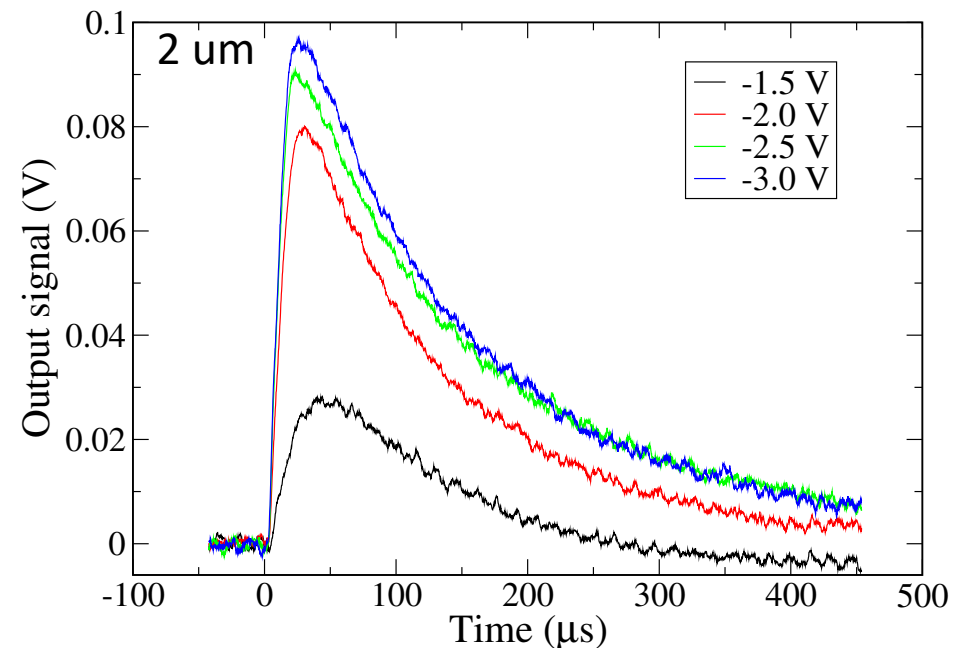
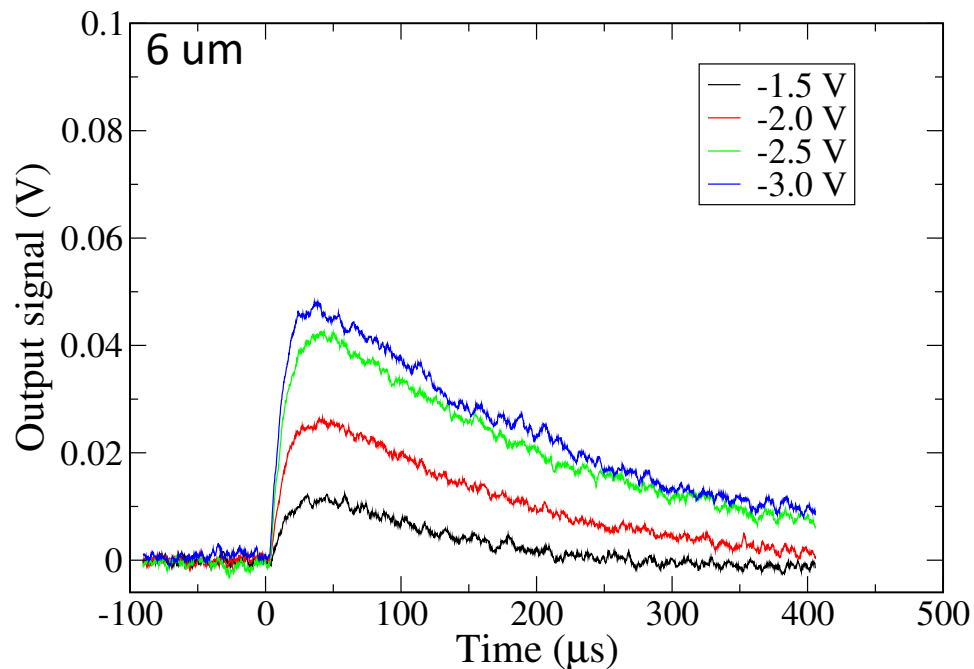
Characterization of micro-channels crystals: Light Intensity dependence

- A slightly super-linear behaviour is found within a light intensity variation of about a factor of eight
- Increase of IPCE as a function of the light intensity
 - at least a component of the gain mechanism is related to a photoconductive effect



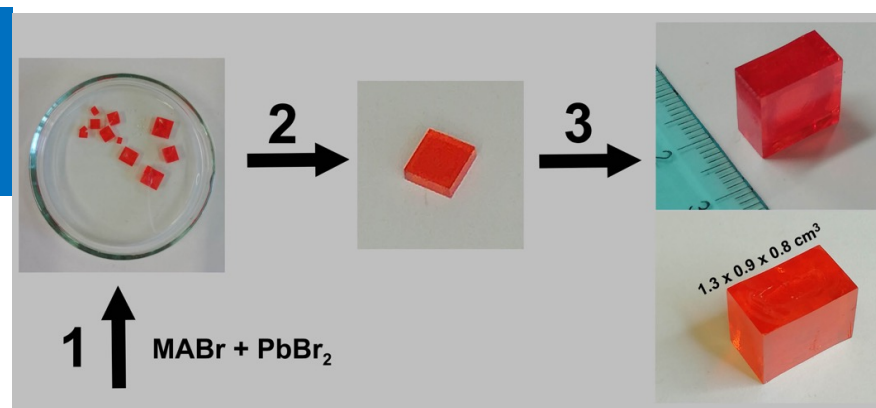
Characterization of micro-channels crystals: Rise Time

- Rise-time measured with light intensity of $0.16 \mu\text{W}/\text{mm}^2$
 - connection to preamplifier and a pulse shaper and the output voltage signal has been measured with an oscilloscope
- Rise-time decrease of $\sim 40 \mu\text{s}$ to $\sim 27 \mu\text{s}$ for applied voltages between -1.5 V and -3 V , corresponding to gain variation of 4
 - Does not suggest gain mechanisms that increase rise times, like those related to trapping

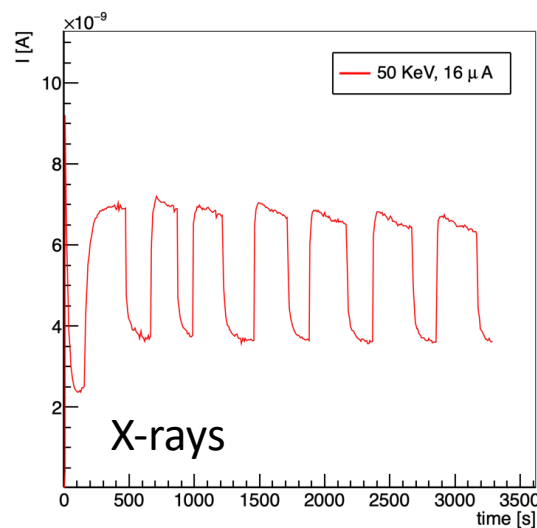
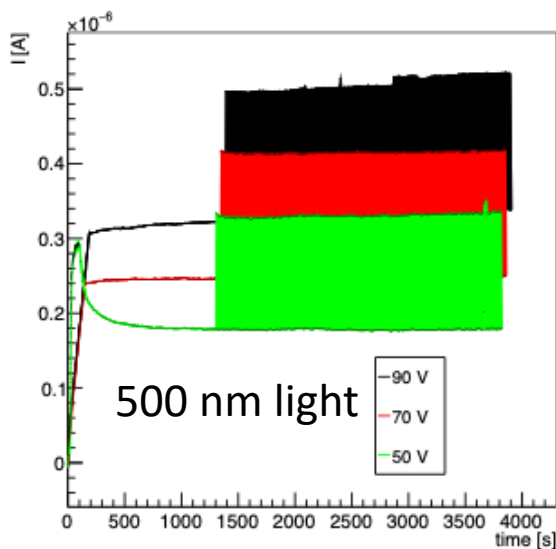
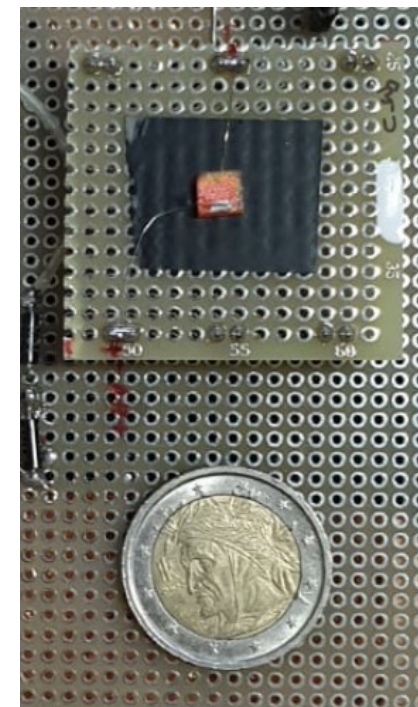
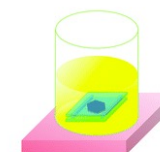


Large Single crystal

- Dimensions up to $1.0 \times 1.5 \text{ cm}^2$ and up to 0.5 cm thick down to $300 \mu\text{m}$ by cutting the crystals along one of the $\{100\}$ cubic planes
- Device realized with Indium Tin Oxide / $\text{CH}_3\text{NH}_3\text{PbBr}_3$ / Au
- Stable response measured
- Due to large thickness, suited for radiation detection (X-rays, charged particles)



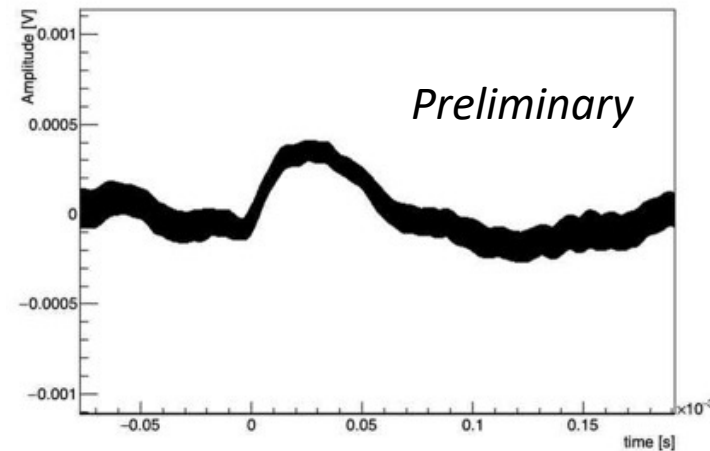
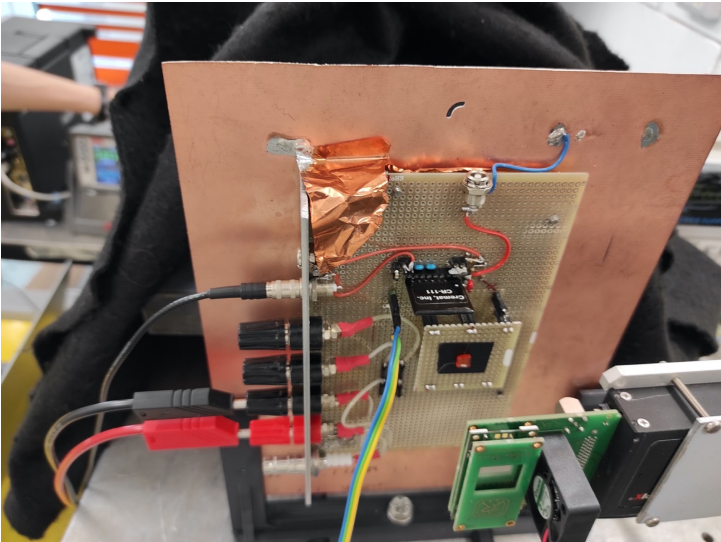
Seeding Techniques
Dip. Chimica Milano



G. Tinti (LNF)

Charged particles detection

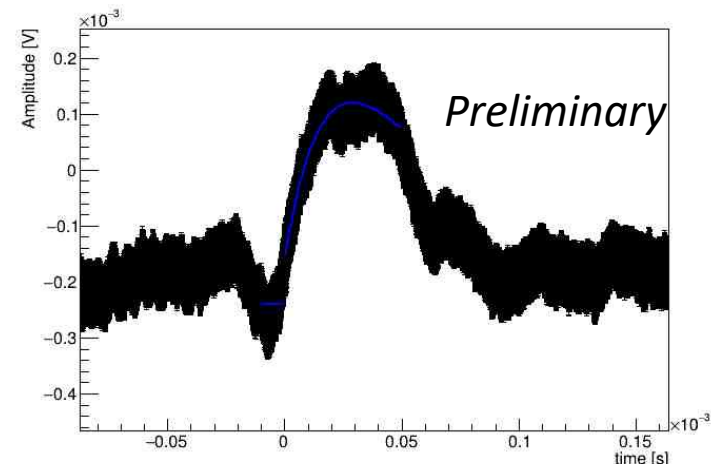
- Test Beam performed with **electrons** of **400 MeV** at Beam Test Facility at LNF
- Bunch of 10 ns, 3.5 mm width
- Beam multiplicity from 1 to 1000 measured from downstream calibrated calorimeter
- Sensitivity down to single particle



< Beam multiplicity >= 1.4

- Observed **cosmics rays** passing through the crystal
- Similar response as single electrons, as expected (MIP)

Deposited patent 102023000012477



Perovskite on CMOS for ionizing detection

- Goal: the feasibility of a hybrid X-ray detector structure combining a perovskite absorption layer and a CMOS silicon active layer
 - Principle: X-ray-generated electrons in the perovskite layer are transferred to silicon and collected by low-capacitance sensing diffusions coupled to in-pixel readout electronics
- The CMOS chips with an area of the order of 1cm^2 are available from ARCADIA INFN project
- On going activity:
 - Test on deposition of perovskite micro-channels through microfluidics technique on CMOS substrates with aluminium pads, used as passive substrates

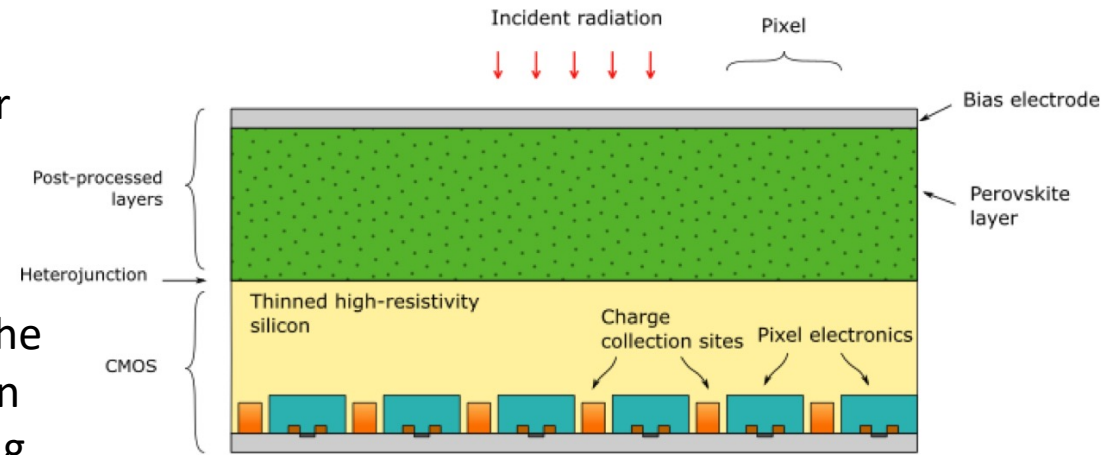
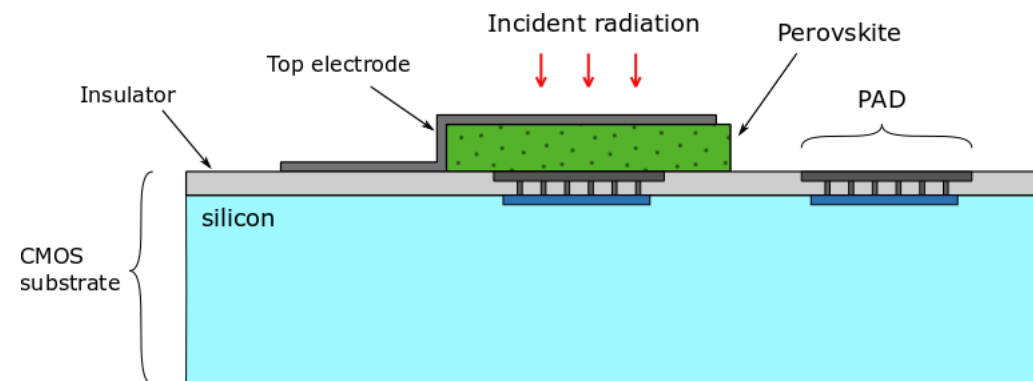
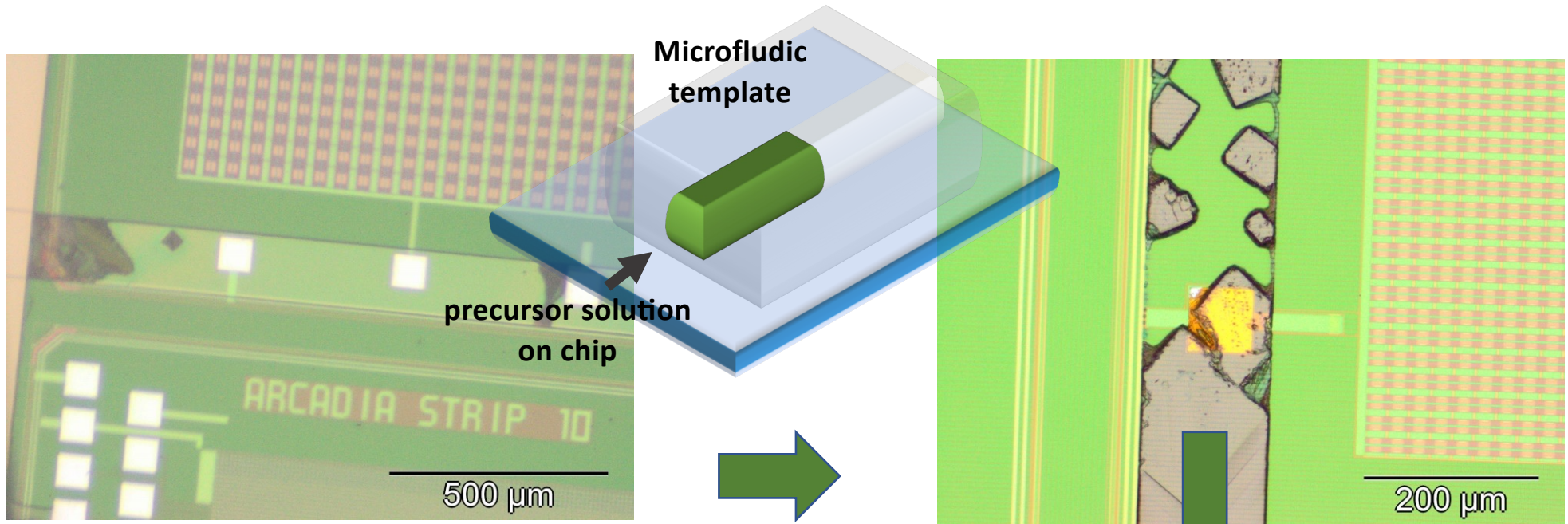


Figure 1. Simplified cross section of the proposed hybrid detector

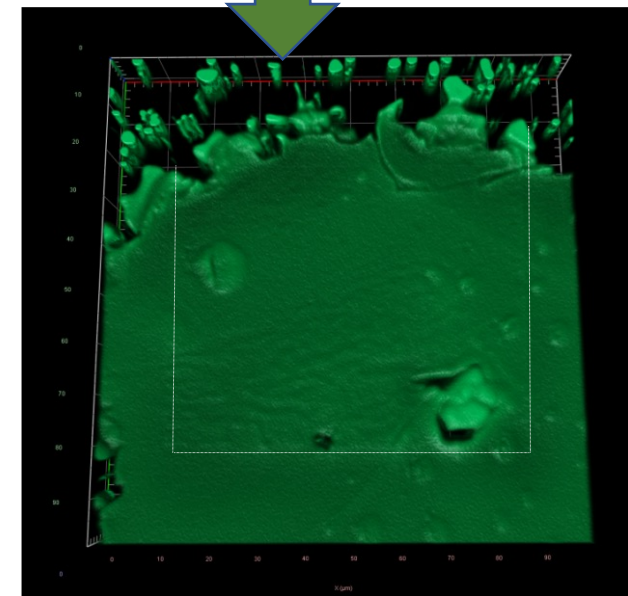
PRIN 2022 project granted
HyPoSiCX = Hybrid Perovskite on Silicon CMOS X-ray Detectors
L.Pancheri, M. Testa, I.Viola



Perovskite on CMOS: Microfluidic-assisted growth



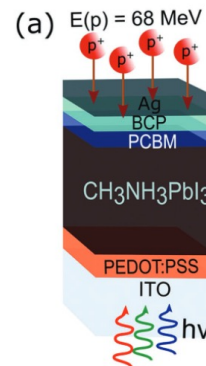
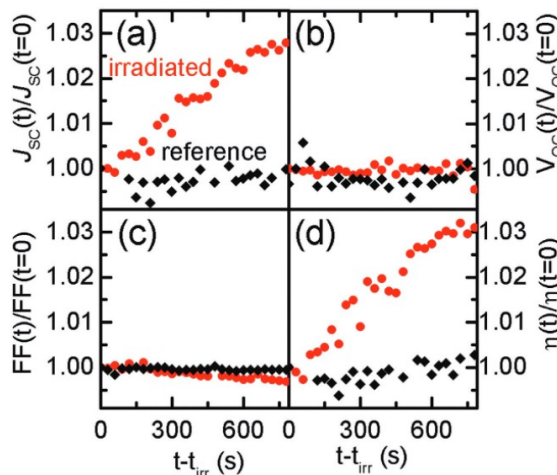
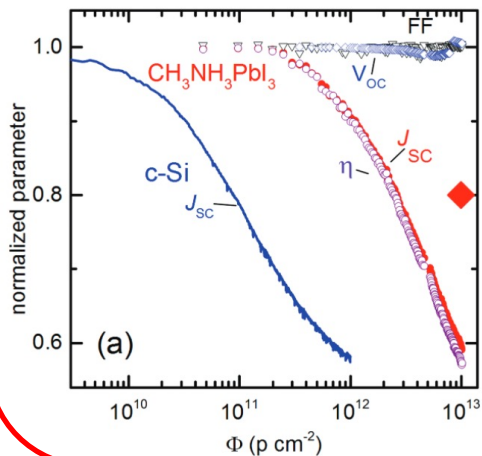
- High crystalline quality of each single crystal (SC);
- Controlled SC dimensions from 500 nm up to 200 μm;
- High aspect ratios for large area devices;
- Growth directly on the device interface;
- Tunability of precursor composition;
- Flexibility in the SC shapes.



Confocal z-stack on a single crystal grown on the chip pad. Dotted lines indicate pad's position.

Radiation Hardness

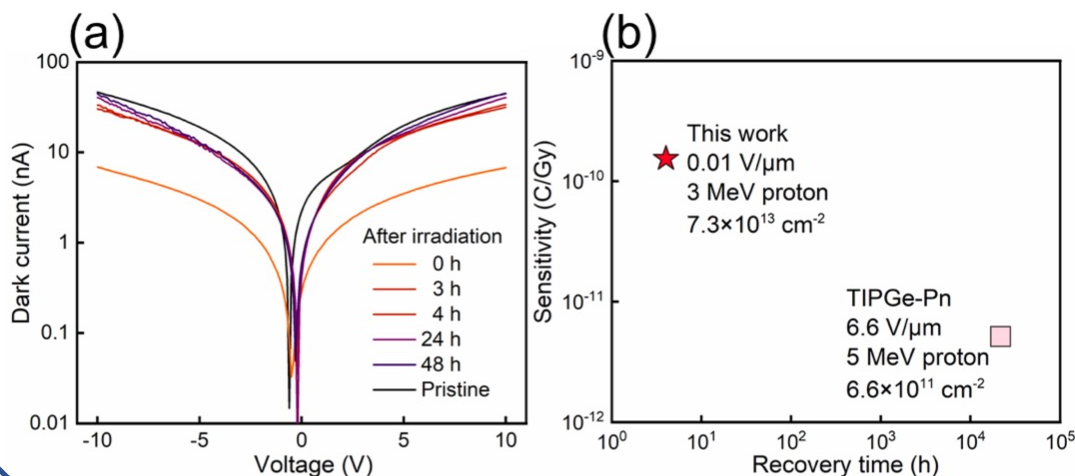
Adv. Material 2016 [10.1002/adma.201603326](https://doi.org/10.1002/adma.201603326)



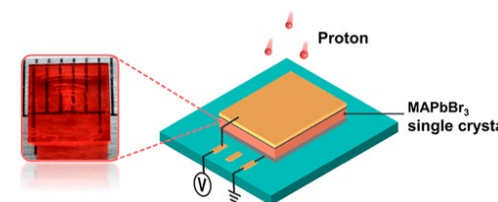
- Solar Cell thin perovskite films
- 68 MeV proton flux 10^{13} p/cm^2
- Damage thr. much larger than commercial silicon-cell
- **Self-healing** of perovskite
 - Displaced atoms migrate in lattice and passivates defects

ACS Appl. Electron. Mater. 2023

[10.1021/acsaelm.2c01406](https://doi.org/10.1021/acsaelm.2c01406)



- Bulk Crystal $2 \times 1.5 \times 1 \text{ mm}^3$
- 3 MeV protons flux of $7.3 \times 10^{13} \text{ p/cm}^2$ (1 MGy)
- **Self-healing** : performance recovered within hours



Conclusions and Outlook

- Halide Perovskite is a promising class of semiconductors for ionizing radiation detection
- Single Bulk crystals:
 - Stable response under visible light and X-rays
 - Sensitivity down to high energy single charged particles
- Single crystal microwires have been growth directly on patterned substrate with precise location and high aspect ratio
 - Visible light detection with high responsivity
 - Next steps:
 - testing with X-rays
 - Integration with CMOS technology

Backup

State of art for perovskite photodetectors

- **Thin films, single crystals** devices can be divided in two categories:
 - Vertical devices
 - without or with small gain and responsivity; short rise time
 - Rise time/decay time down to $O(1)$ μs ; EQE up to $\sim 80\%$.
 - Lateral devices
 - with gain, slow; generally lateral devices

Table 2 Summary of the reported broadband perovskite photodetectors

Materials (device structure)	Response range (nm)	EQE (%)	R (A W^{-1})	D^* (Jones)	τ_r/τ_f	Ref.
MAPbI ₃ thin films (vertical)	400–800	—	0.4	10^{12c}	1.2/3.2 μs	174
MAPbI ₃ thin films (vertical)	375–800	84	0.339	5×10^{12d}	—	175
MAPbCl ₃ thin films (vertical)	300–400	24	0.071	2.87×10^{10d}	—	211
MAPbI ₃ thin films (vertical-MSM)	300–800	$\sim 10^4$	>150	—	—/0.67 μs	172
MAPbI ₃ thin films (lateral-MSM)	300–800	—	0.11	1.3×10^{11d}	$<90/<20$ ms	212
MAPbI ₃ thin films (lateral-MSM)	440–800	4.1×10^4	219	3.1×10^{12d}	—	171
MAPbI ₃ thin films (lateral)	400–800	80	320	—	6.5/5.0 μs	43
MAPbI _{3-x} Cl _x thin films (lateral)	254 & 350–800	3832	7.85	—	0.2/0.7 μs	145
MAPbI _{3-x} Cl _x thin films (lateral)	405–808	1808	11.5	4.93×10^{12d}	—	146
MAPbBr _{3-x} I _x thin films (lateral)	300–600	—	0.055	—	$<20/<20$ μs	147
MA _{0.5} FA _{0.5} Pb _{0.5} Sn _{0.5} I ₃ thin films (vertical)	350–1000	—	>0.2	$>10^{12c}$	—/7.4 μs	149
(FASnI ₃) _{0.6} (MAPbI ₃) _{0.4} thin films (vertical)	300–1000	~ 80	>0.4	$>10^{12c}$	6.9/9.1 μs	47
FA _{1-x} Cs _x PbI ₃ thin films (lateral)	240–750	—	5.7	2.7×10^{13d}	45/91 ns	150
MAPbI ₃ single crystal (lateral)	275–790	2.22×10^5	953	—	74/58 μs	182
MAPbI ₃ single crystal (lateral) ^a	600–950	22	0.15	—	0.12/0.08 s	183
MAPbBr ₃ single crystal (lateral) ^a	400–890	25	0.1	—	0.08/0.09 s	183
Integrated MAPbCl ₃ single crystals (lateral)	340–430	100 (G)	11	10^{12d}	—/1 ms	185
Integrated MAPbBr ₃ single crystals (lateral)	375–575	1.4×10^4 (G)	4500	$>10^{13d}$	25/25 μs	184
FAPbI ₃ single crystalline wafer (lateral)	—	900	4.5	—	8.3/7.5 ms	186
MAPbI ₃ thin single crystal (vertical)	350–800	62	0.32	$>10^{13c}$	—/3.1 μs	187
MAPbBr ₃ thin single crystal (vertical)	350–550	60	0.26	—	—/7.2 μs	187
MAPbBr ₃ single crystalline thin film (vertical)	—	5×10^7 (G)	1.6×10^7	—	81/892 μs	188

J. Mater. Chem. C,
2019, 7, 1741

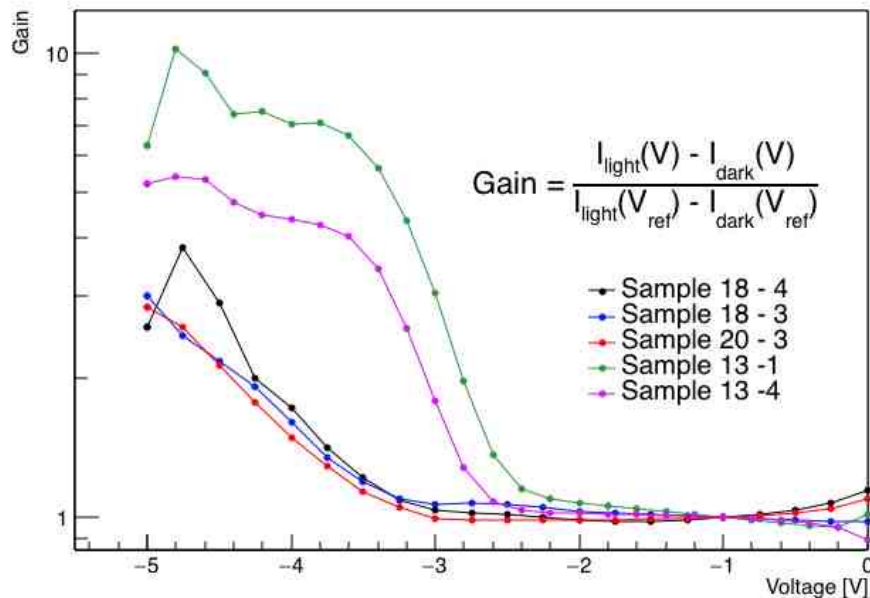
- **Micro-sized** photodetector development steadily growing [*Adv. Funct. Mater.* **2022**, 32, 2200385]
 - Few examples for vertical devices with low responsivity and/or slow rise time
 - 0.38 AW^{-1} [*Li et al Advanced Optical Materials* 2021, 9 210037]
 - Slow rise time [*Weng et al, Advanced Materials* 2020, 32, 1908340,11]

Film-based devices: what we learned

- Gain observed in a fraction of devices
 - Not dependent on different hole transport layers: PTAA or MD89, none



- Significant differences among devices and pixels on the same devices

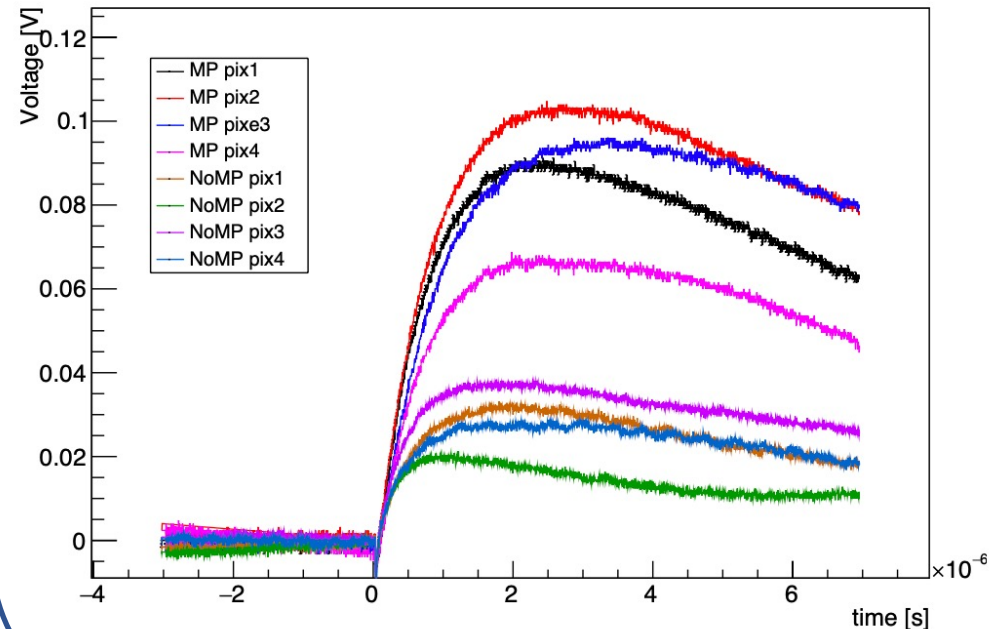


- Rise-time of $\sim 2\mu\text{s}$ dominated by transport in the mesoporous TiO_2 transport layer.
- Less impact from area
- Planar TiO_2 : $0.5 - 1\ \mu\text{s}$
- Mesoporous TiO_2 : $1.3-2\ \mu\text{s}$
- Small area Mesoporous TiO_2 : $\sim 1\ \mu\text{s}$

Def Area

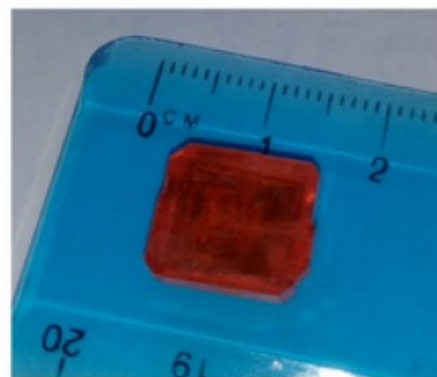


Small Area

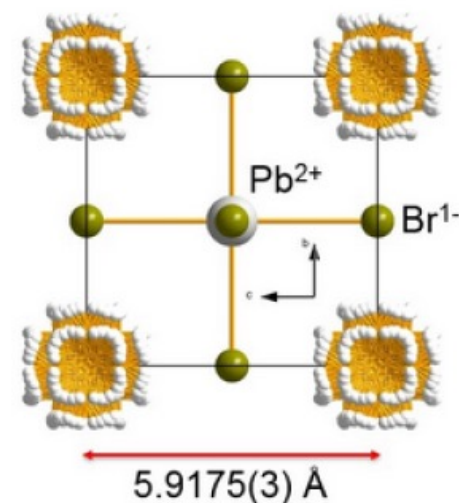


Large Single crystal production

- $\text{CH}_3\text{NH}_3\text{PbBr}_3$ single crystals synthesized by temperature raising method from a dimethylformamide solution of the reactants
 - Dimensions up to $1.0 \times 1.5 \text{ cm}^2$ and up to 0.5 cm thick down to $300 \mu\text{m}$ by cutting the crystals along one of the $\{100\}$ cubic planes
- X-ray diffraction:
 - Transitions observed at various temperatures in agreement with literature
 - At T_{room} complete full sphere of data: The methylammonium cation occupies the cuboctahedral sites and is disordered over 48 crystallographic equivalent directions

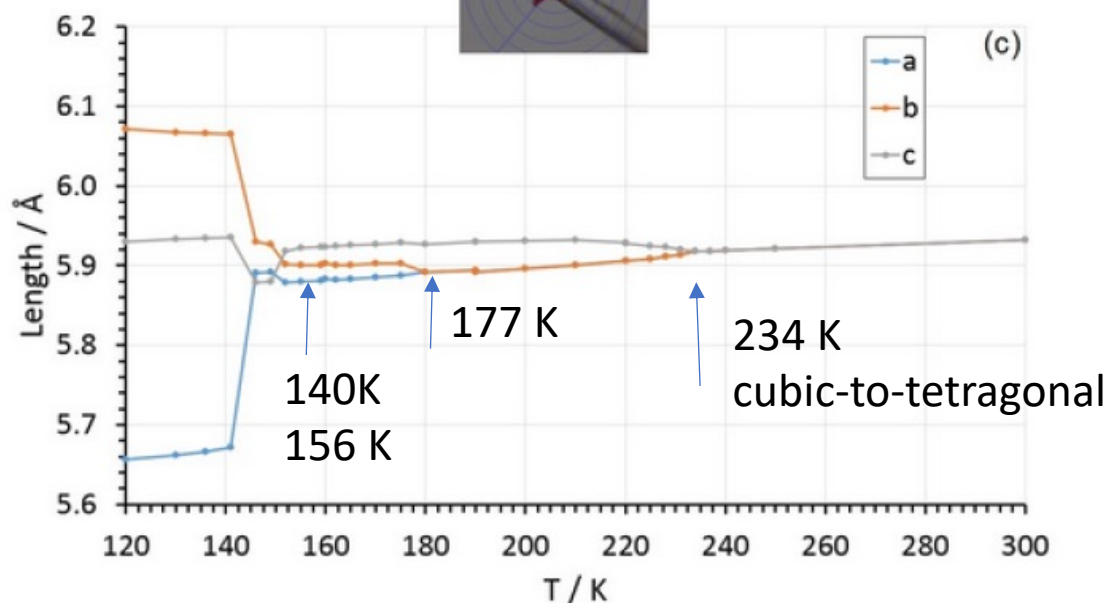


(a)



(b)

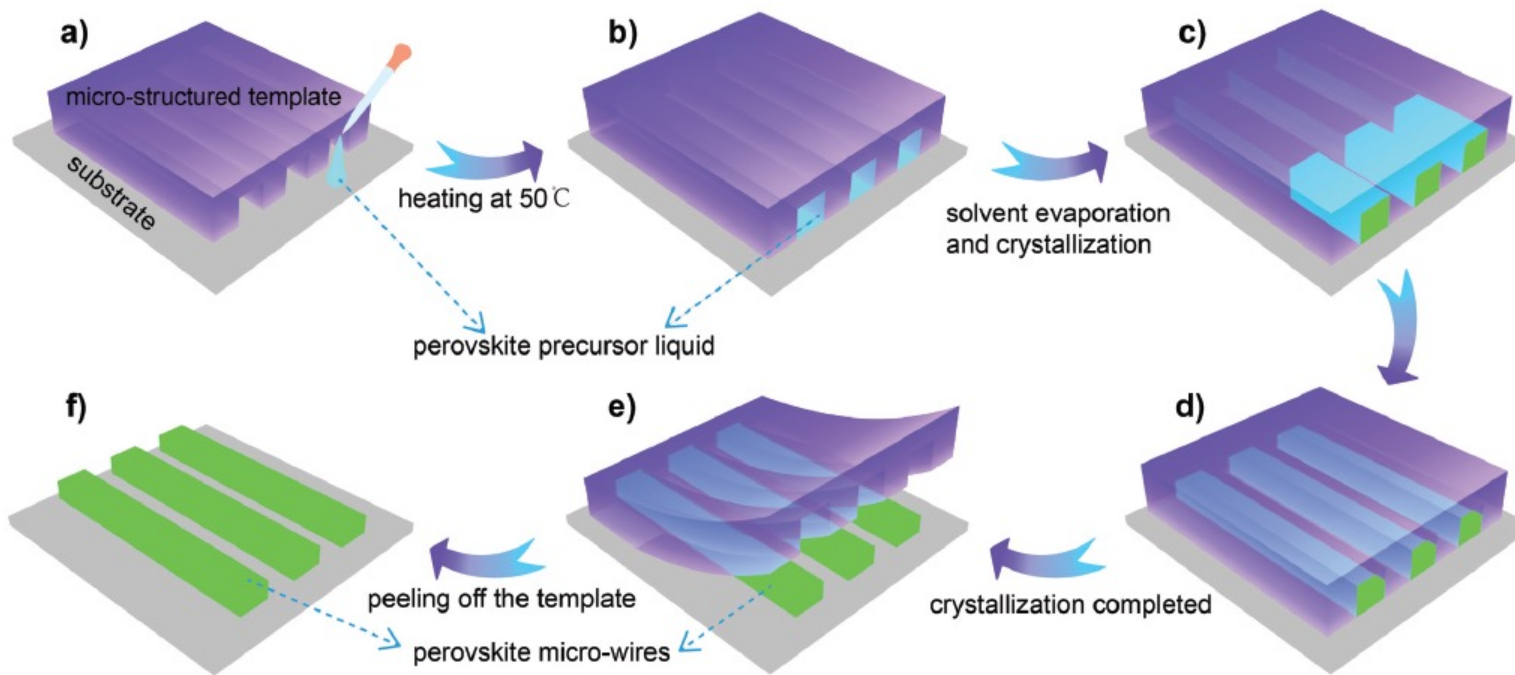
X-ray diffraction $f(T)$



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Microfluidic-assisted perovskite crystallization



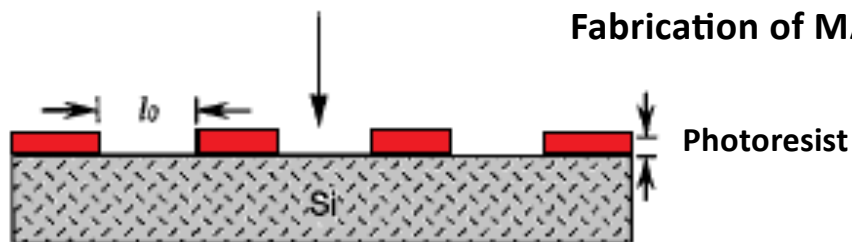
S.-X- Li, *Nanoscale*, 11, 2019

- Manipulation of fluids at the microscale
 - High control over the crystallization kinetics
- ↓
- Excellent uniformity, crystallinity and structural quality
 - Allow perovskite crystallization on functional device
 - Reduce significant batch-to-batch variability
 - Allow patterning over large area, on nonplanar surfaces, with sub-micrometer resolution

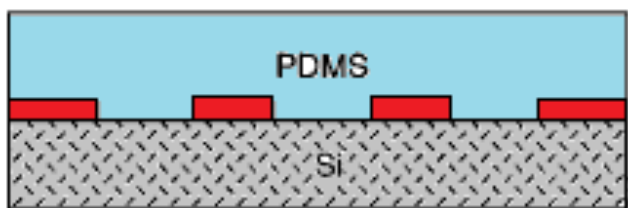
Microfluidics: Soft-Lithography fabrication technique

PHOTOLITHOGRAPHY

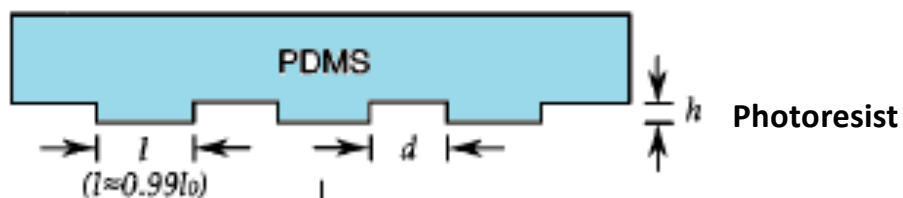
Fabrication of MASTER



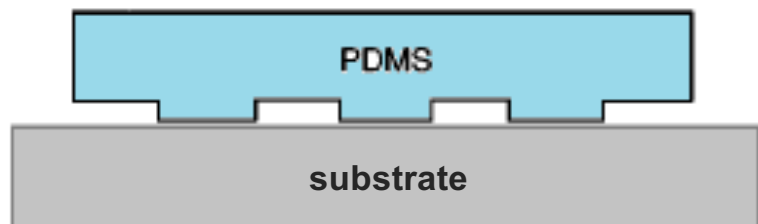
Cast PDMS on the master



Cure PDMS and peel off

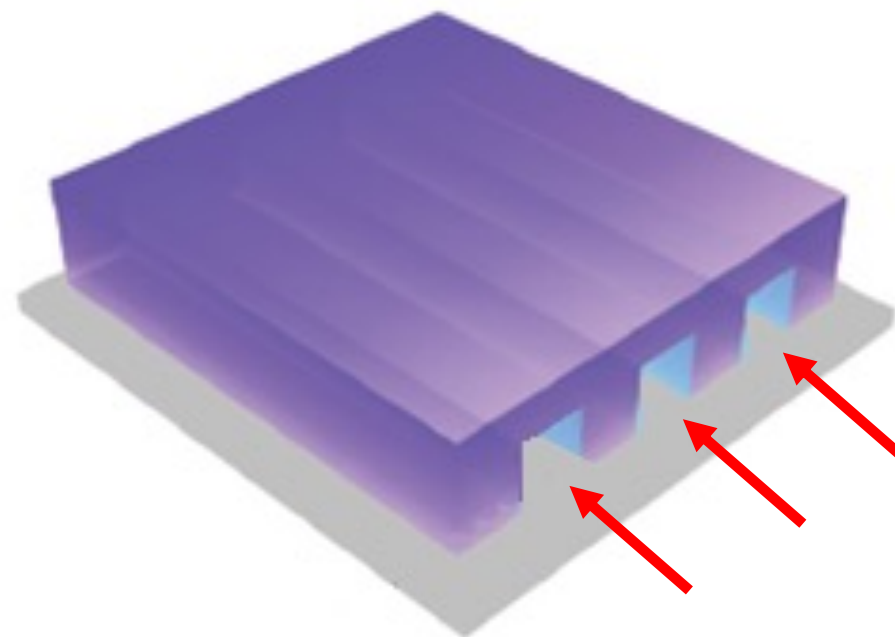


Seal to substrate



Ready Device

MICROFLUIDIC DEVICE



Perovskite precursor solution

Electronic/Optical Properties

Material	h^+ effective mass [m_e]	e^- effective mass [m_e]	μ_{h^+} [$\text{cm}^2 \text{V}^{-1} \text{s}^{-1}$]	μ_{e^-} [$\text{cm}^2 \text{V}^{-1} \text{s}^{-1}$]
Si ^{b)}	0.54 ^[109]	0.32 ^[110]	500 ^[109]	1500 ^[110]
GaAs ^{b)}	0.53 ^[113]	0.06 ^[113]	400 ^[113]	8000 ^[113]
CdTe ^{b)}	0.72 ^[115,116]	0.11 ^[115,116]	100 ^[117]	1100 ^[117]
CuInS ₂	≈ 1 ^[120]	0.16 ^[120]	≈ 20 ^[120]	≈ 150 ^[120]
MAPbI ₃	0.26 ^[122,123]	0.23 ^[122,123]	≤ 160 ^[124]	≤ 70 ^[124]
MAPbBr ₃ ^{c)}	0.15 ^[127]	0.25 ^[127]	≤ 220 ^[128]	≤ 190 ^[129]

Egger et al. *Adv. Mater.* **2018**, 1800691

Electronic properties are aligned with conventional semiconductors and much better than typical solution process organic semiconductors.

